



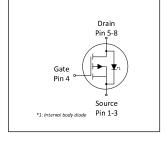
MOSFET

OptiMOS™3 Power-MOSFET, 30 V

Features

- Fast switching MOSFET for SMPS
- Optimized technology for DC/DC converters
 Qualified according to JEDEC¹⁾ for target applications
 N-channel; Logic level
- Excellent gate charge x R_{DS(on)} product (FOM)
- Very low on-resistance R_{DS(on)}
- Superior thermal resistance
- Avalanche rated
- Pb-free plating; RoHS compliant
- Halogen-free according to IEC61249-2-21









Key Performance Parameters Table 1

Parameter	Value	Unit
V _{DS}	30	V
R _{DS(on),max}	8.8	mΩ
ID	50	A

Type / Ordering Code	Package	Marking	Related Links
BSZ088N03LS G	PG-TSDSON-8	088N03L	-



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Deveryoter	C. make al	Values					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	/ _D		- - -	50 32 42 26 12	A	$V_{GS}=10 V, T_{C}=25 °C$ $V_{GS}=10 V, T_{C}=100 °C$ $V_{GS}=4.5 V, T_{C}=25 °C$ $V_{GS}=4.5 V, T_{C}=100 °C$ $V_{GS}=10 V, T_{A}=25 °C, R_{thJA}=60 \text{ K/W}^{2)}$	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	200	A	<i>T</i> _c =25 °C	
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	20	A	<i>T</i> _c =25 °C	
Avalanche energy, single pulse	EAS	-	-	25	mJ	I _D =20 A, R _{GS} =25 Ω	
Reverse diode d <i>v</i> /d <i>t</i>	d <i>v</i> /dt	-	-	6	kV/µs	/ _D =40 A, V _{DS} =24 V, d <i>i</i> /d <i>t</i> =200 A/μs, / _{J,max} =150 °C	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	35 2.1	-	<i>T</i> _c =25 °C <i>T</i> _A =25 °C, <i>R</i> _{thJA} =60 K/W ²⁾	
Operating and storage temperature	$T_{\rm j},~T_{ m stg}$	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56	

2 **Thermal characteristics**

Table 3 **Thermal characteristics**

Deveneder	Symphol	Values			11	Nata / Taat Canditian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	3.6	K/W	-	
Device on PCB, 6 cm ² cooling area ²⁾	R _{thJA}	-	-	60	K/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. ²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 μm thick) copper area for drain

⁽⁴⁾ See figure 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Demonster	C. makes		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	30	-	-	V	V _{GS} =0 V, <i>I</i> _D =1 mA	
Gate threshold voltage	V _{GS(th)}	1	-	2.2	V	V _{DS} =V _{GS} , <i>I</i> _D =250 μA	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =30 V, V _{GS} =0 V, T _j =25 °C V _{DS} =30 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	10.4 7.3	13 8.8	mΩ	V _{GS} =4.5 V, <i>I</i> _D =20 A V _{GS} =10 V, <i>I</i> _D =20 A	
Gate resistance	R _G	0.5	1.0	1.8	Ω	-	
Transconductance	$g_{ m fs}$	28	57	-	S	V _{DS} >2 I _D R _{DS(on)max} , I _D =30 A	

Table 5Dynamic characteristics

Devenueter	Courseland	Values			11		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance ¹⁾	Ciss	-	1300	1700	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz	
Output capacitance ¹⁾	Coss	-	510	680	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz	
Reverse transfer capacitance	C _{rss}	-	25	-	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz	
Turn-on delay time	t _{d(on)}	-	3.3	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G}$ =1.6 Ω	
Rise time	t _r	-	2.8	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G}$ =1.6 Ω	
Turn-off delay time	$t_{\rm d(off)}$	-	15	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G}$ =1.6 Ω	
Fall time	t _f	-	2.6	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G}$ =1.6 Ω	

Gate charge characteristics²⁾ Table 6

Demonster	C. maked		Values				
Parameter	Symbol	Min.	Typ.	Max.	Unit	Note / Test Condition	
Gate to source charge ¹⁾	Q _{gs}	-	4.0	5.4	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V	
Gate charge at threshold ¹⁾	Q _{g(th)}	-	1.9	2.6	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V	
Gate to drain charge ¹⁾	Q _{gd}	-	1.8	3.0	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V	
Switching charge ¹⁾	Qsw	-	3.9	5.8	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V	
Gate charge total ¹⁾	Qg	-	7.5	10.0	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V	
Gate plateau voltage	V _{plateau}	-	3.4	-	V	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V	
Gate charge total	Qg	-	16	21	-	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 10 V	
Gate charge total, sync. FET	Q _{g(sync)}	-	6	8.6	nC	V _{DS} =0.1 V, V _{GS} =0 to 4.5 V	
Output charge	Qoss	-	13	17	-	V _{DD} =15 V, V _{GS} =0 V	

¹⁾ Defined by design
 ²⁾ See "Gate charge waveforms" for parameter definition

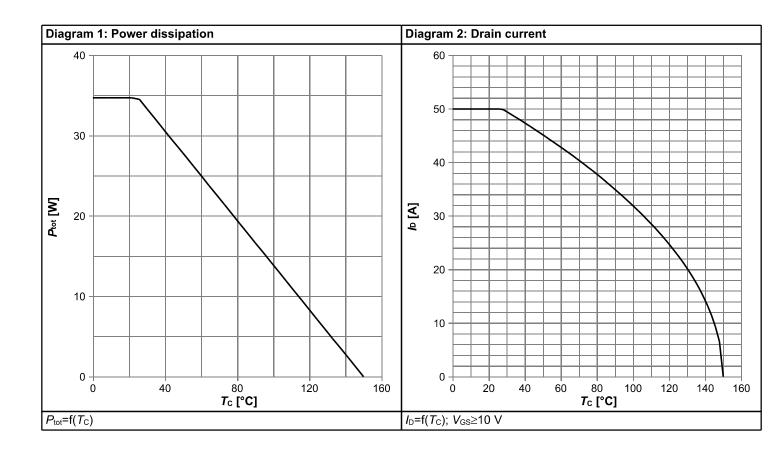


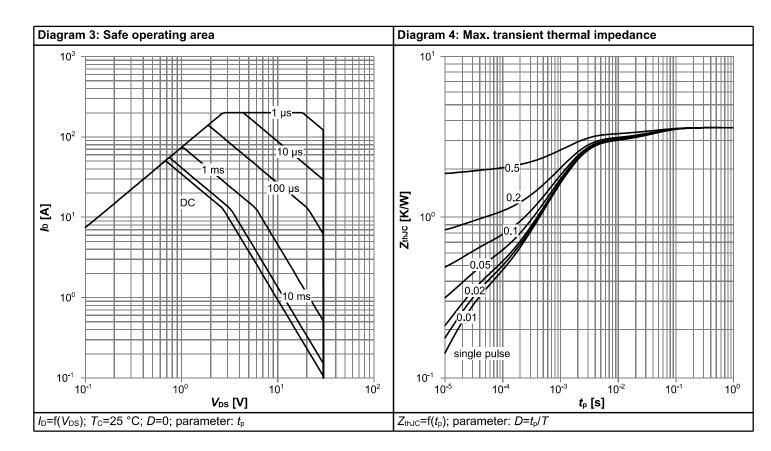
Table 7Reverse diode

Peremeter	Symbol	Values			Unit	Note / Test Condition	
Parameter	Symbol	Min.	Typ.	Max.	Onit		
Diode continuous forward current	ls	-	-	32	А	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	160	А	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.86	1.1	V	V _{GS} =0 V, <i>I</i> _F =20 A, <i>T</i> _j =25 °C	
Reverse recovery charge	Qrr	-	-	10	nC	V _R =15 V, <i>I</i> _F = <i>I</i> _S , d <i>i</i> _F /d <i>t</i> =400 A/µs	

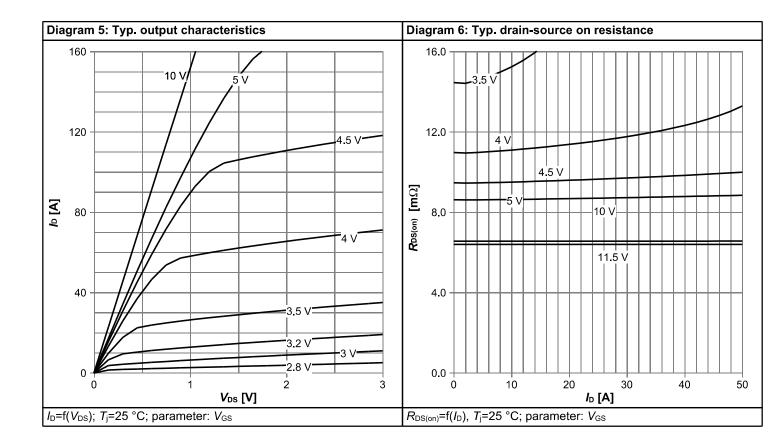


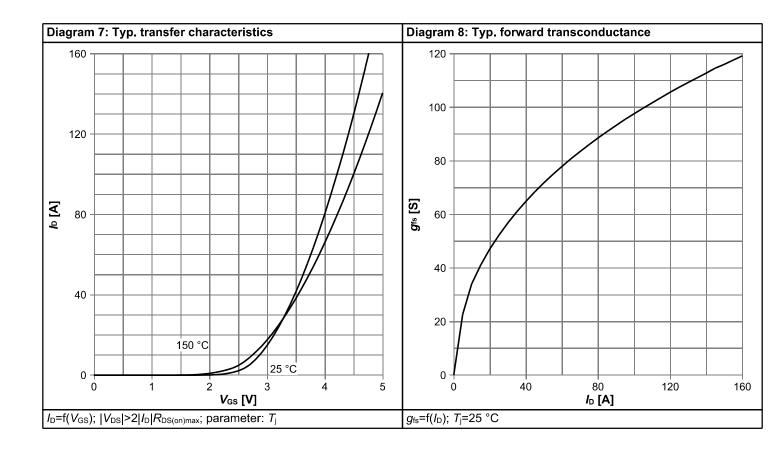
4 Electrical characteristics diagrams



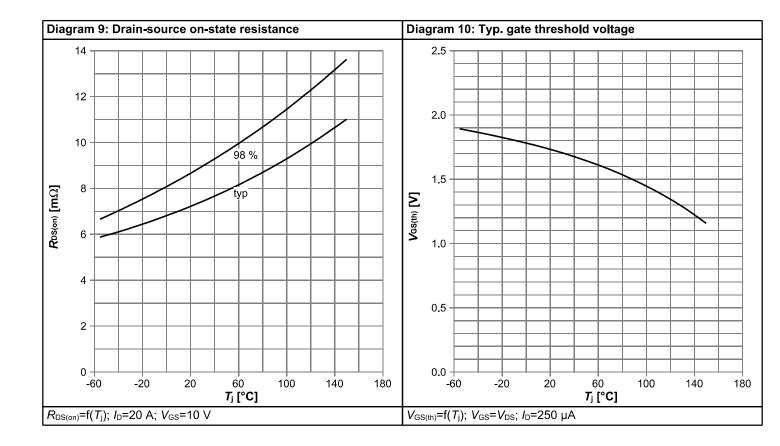


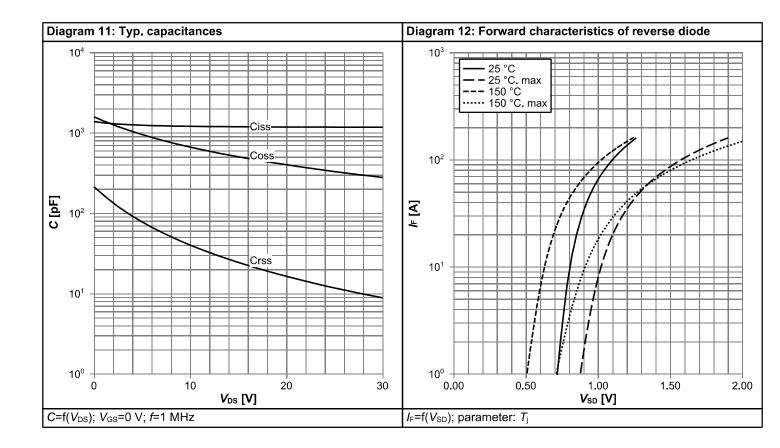




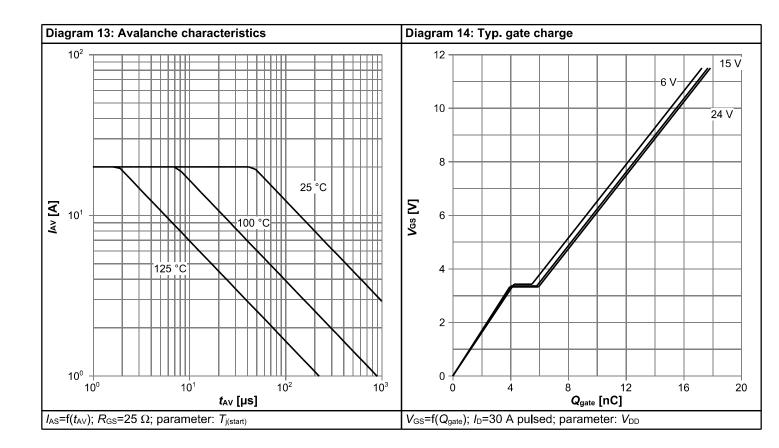


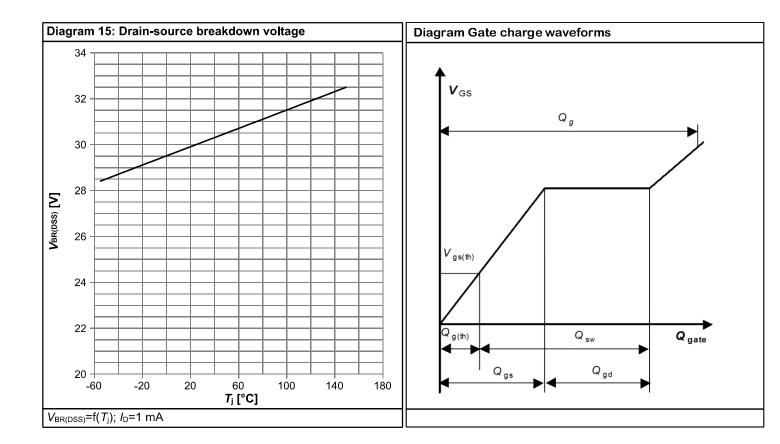






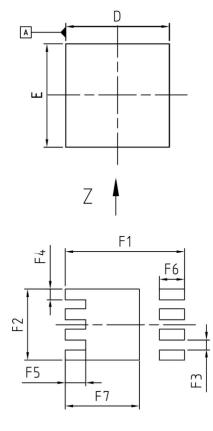


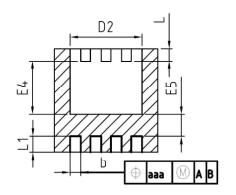


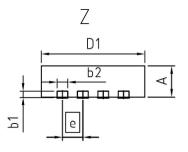




5 Package Outlines







DIM	MILLIME	ETERS	INCH	IES	
DIM	MIN	MAX	MIN	MAX	
А	0.90	1.10	0.035	0.043	
Ь	0.24	0.44	0.009	0.017	
b1	0.10	0.30	0.004	0.012	
b2	0.20	0.44	0.008	0.017	
D=D1	3.20	3.40	0.126	0.134	
D2	2.15	2.45	0.085	0.096	
E	3.20	3.40	0.126	0.134	
E4	1.60	1.81	0.063	0.071	
E5	0.59	0.86	0.023	0.034	
е	0.0	65	0.026		
Ν	8	3	8		
L	0.30	0.56	0.012	0.022	
L1	0.33	0.60	0.013	0.024	
aaa	0.2	5	0.010		
F1	3.8	0	0.1	50	
F2	2.2	9	0.0	90	
F3	0.3	1	0.0	12	
F4	0.3	4	0.013		
F5	0.6	5	0.0	26	
F6	0.8	0	0.0	31	
F7	2.3	6	0.0	93	

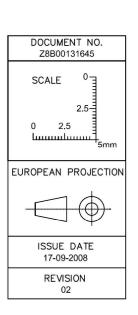


Figure 1 Outline PG-TSDSON-8, dimensions in mm/inches



Revision History

BSZ088N03LS G

Revision: 2021-04-09, Rev. 2.1

Previous Revision					
Revision	Date	Subjects (major changes since last revision)			
2.1	2021-04-09	Update Id max current rating			

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